

## Materials Declaration

<b>Package</b>	TO78
<b>Body Size</b>	
<b>Lead Count</b>	6
<b>Option</b>	SnPb

Cans			
Item	% of Cans	Weight (g)	PPM
Nickel	100.0	3.10E-01	328126

Headers			
Item	% of Headers	Weight (g)	PPM
Eyelet (Kovar)	42.1	2.52E-01	266734
Glass	27.8	1.66E-01	175706
Nail Lead (Kovar)	24.4	1.47E-01	155595
Spot Lead (Kovar)	4.1	2.44E-02	25827
Nickel	1.4	8.52E-03	9018
Au	0.2	1.44E-03	1524

Bonding Wires			
Item	% of Wire	Weight (g)	PPM
Aluminum	100.0	1.20E-03	1270

Chip			
Item	% of Chip	Weight (g)	PPM
Si	100.0	3.00E-03	3175

Die Attach Paste			
Item	% of Die Attach	Weight (g)	PPM
Silver Filler	80.0	9.60E-04	1016
Cyanate ester resin	20.0	2.40E-04	254

Solder			
Item	% of Solder	Weight (g)	PPM
Tin	63.0	1.90E-02	20111
Lead	37.0	1.10E-02	11643

Package Totals	
Weight (g)	PPM
9.45 E-01	1000000

Note: The information provided in this declaration are true to the best of ADI's knowledge  
 ADI derived most of the information listed in this declaration from documents provided by third parties, and assumes no liability to  
 any inaccuracy of such information.